

Film Capacitors

Metallized Polyester Film Capacitors (MKT-S)

Series/Type: B32537
Date: May 2009

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32537B8335J000		2012-10-19	2013-01-19	2013-04-19
B32537B8334K000		2012-10-19	2013-01-19	2013-04-19
B32537B8334J000		2012-10-19	2013-01-19	2013-04-19

© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32537B8333K000		2012-10-19	2013-01-19	2013-04-19
B32537B8333J000		2012-10-19	2013-01-19	2013-04-19
B32537B8225K000		2012-10-19	2013-01-19	2013-04-19
B32537B8225J000		2012-10-19	2013-01-19	2013-04-19
B32537B8224K000		2012-10-19	2013-01-19	2013-04-19
B32537B8224J000		2012-10-19	2013-01-19	2013-04-19
B32537B8155K000		2012-10-19	2013-01-19	2013-04-19
B32537B8155J000		2012-10-19	2013-01-19	2013-04-19
B32537B8154K000		2012-10-19	2013-01-19	2013-04-19
B32537B8154J000		2012-10-19	2013-01-19	2013-04-19
B32537B8105K000		2012-10-19	2013-01-19	2013-04-19
B32537B8105J000		2012-10-19	2013-01-19	2013-04-19
B32537B8104K000		2012-10-19	2013-01-19	2013-04-19
B32537B8104J000		2012-10-19	2013-01-19	2013-04-19
B32537B5685K000		2012-10-19	2013-01-19	2013-04-19
B32537B5685J000		2012-10-19	2013-01-19	2013-04-19
B32537B5684K000		2012-10-19	2013-01-19	2013-04-19
B32537B5684J000		2012-10-19	2013-01-19	2013-04-19
B32537B5475K000		2012-10-19	2013-01-19	2013-04-19
B32537B5475J000		2012-10-19	2013-01-19	2013-04-19
B32537B5474K000		2012-10-19	2013-01-19	2013-04-19
B32537B5474J000		2012-10-19	2013-01-19	2013-04-19
B32537B2106J000		2012-10-19	2013-01-19	2013-04-19
B32537B2106K000		2012-10-19	2013-01-19	2013-04-19
B32537B5335J000		2012-10-19	2013-01-19	2013-04-19
B32537B5335K000		2012-10-19	2013-01-19	2013-04-19
B32537B5225K000		2012-10-19	2013-01-19	2013-04-19
B32537B5225J000		2012-10-19	2013-01-19	2013-04-19
B32537B5155K000		2012-10-19	2013-01-19	2013-04-19
B32537B5155J000		2012-10-19	2013-01-19	2013-04-19
B32537B5106K000		2012-10-19	2013-01-19	2013-04-19
B32537B5106J000		2012-10-19	2013-01-19	2013-04-19
B32537B5105K000		2012-10-19	2013-01-19	2013-04-19
B32537B5105J000		2012-10-19	2013-01-19	2013-04-19
B32537B3685K000		2012-10-19	2013-01-19	2013-04-19
B32537B3685J000		2012-10-19	2013-01-19	2013-04-19
B32537B3684K000		2012-10-19	2013-01-19	2013-04-19
B32537B3684J000		2012-10-19	2013-01-19	2013-04-19



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32537B3475K000		2012-10-19	2013-01-19	2013-04-19
B32537B3475J000		2012-10-19	2013-01-19	2013-04-19
B32537B3474K000		2012-10-19	2013-01-19	2013-04-19
B32537B3474J000		2012-10-19	2013-01-19	2013-04-19
B32537B3335K000		2012-10-19	2013-01-19	2013-04-19
B32537B3335J000		2012-10-19	2013-01-19	2013-04-19
B32537B3334K000		2012-10-19	2013-01-19	2013-04-19
B32537B3334J000		2012-10-19	2013-01-19	2013-04-19
B32537B3225K000		2012-10-19	2013-01-19	2013-04-19
B32537B3225J000		2012-10-19	2013-01-19	2013-04-19
B32537B3224K000		2012-10-19	2013-01-19	2013-04-19
B32537B3224J000		2012-10-19	2013-01-19	2013-04-19
B32537B3155K000		2012-10-19	2013-01-19	2013-04-19
B32537B3155J000		2012-10-19	2013-01-19	2013-04-19
B32537B3154K000		2012-10-19	2013-01-19	2013-04-19
B32537B3154J000		2012-10-19	2013-01-19	2013-04-19
B32537B3106K000		2012-10-19	2013-01-19	2013-04-19
B32537B3106J000		2012-10-19	2013-01-19	2013-04-19
B32537B3105K000		2012-10-19	2013-01-19	2013-04-19
B32537B3105J000		2012-10-19	2013-01-19	2013-04-19
B32537B3104K000		2012-10-19	2013-01-19	2013-04-19
B32537B3104J000		2012-10-19	2013-01-19	2013-04-19
B32537B2685K000		2012-10-19	2013-01-19	2013-04-19
B32537B2685J000		2012-10-19	2013-01-19	2013-04-19
B32537B2684K000		2012-10-19	2013-01-19	2013-04-19
B32537B2684J000		2012-10-19	2013-01-19	2013-04-19
B32537B2475K000		2012-10-19	2013-01-19	2013-04-19
B32537B2475J000		2012-10-19	2013-01-19	2013-04-19
B32537B2474K000		2012-10-19	2013-01-19	2013-04-19
B32537B2474J000		2012-10-19	2013-01-19	2013-04-19
B32537B2335K000		2012-10-19	2013-01-19	2013-04-19
B32537B2335J000		2012-10-19	2013-01-19	2013-04-19
B32537B2334K000		2012-10-19	2013-01-19	2013-04-19
B32537B2334J000		2012-10-19	2013-01-19	2013-04-19
B32537B2225K000		2012-10-19	2013-01-19	2013-04-19
B32537B2225J000		2012-10-19	2013-01-19	2013-04-19
B32537B2224K000		2012-10-19	2013-01-19	2013-04-19
B32537B2224J000		2012-10-19	2013-01-19	2013-04-19



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32537B2155K000		2012-10-19	2013-01-19	2013-04-19
B32537B2155J000		2012-10-19	2013-01-19	2013-04-19
B32537B2154K000		2012-10-19	2013-01-19	2013-04-19
B32537B2154J000		2012-10-19	2013-01-19	2013-04-19
B32537B2105K000		2012-10-19	2013-01-19	2013-04-19
B32537B2105J000		2012-10-19	2013-01-19	2013-04-19
B32537B2104K000		2012-10-19	2013-01-19	2013-04-19
B32537B2104J000		2012-10-19	2013-01-19	2013-04-19
B32537B8684K000		2012-10-19	2013-01-19	2013-04-19
B32537B8684J000		2012-10-19	2013-01-19	2013-04-19
B32537B8683K000		2012-10-19	2013-01-19	2013-04-19
B32537B8683J000		2012-10-19	2013-01-19	2013-04-19
B32537B8475K000		2012-10-19	2013-01-19	2013-04-19
B32537B8475J000		2012-10-19	2013-01-19	2013-04-19
B32537B8474K000		2012-10-19	2013-01-19	2013-04-19
B32537B8474J000		2012-10-19	2013-01-19	2013-04-19
B32537B5335K000		2012-10-19	2013-01-19	2013-04-19
B32537B5335J000		2012-10-19	2013-01-19	2013-04-19
B32537B1685K000		2012-10-19	2013-01-19	2013-04-19
B32537B1685J000		2012-10-19	2013-01-19	2013-04-19
B32537B1684K000		2012-10-19	2013-01-19	2013-04-19
B32537B1684J000		2012-10-19	2013-01-19	2013-04-19
B32537B1476K000		2012-10-19	2013-01-19	2013-04-19
B32537B1476J000		2012-10-19	2013-01-19	2013-04-19
B32537B1475K000		2012-10-19	2013-01-19	2013-04-19
B32537B1475J000		2012-10-19	2013-01-19	2013-04-19
B32537B1474K000		2012-10-19	2013-01-19	2013-04-19
B32537B1474J000		2012-10-19	2013-01-19	2013-04-19
B32537B1335K000		2012-10-19	2013-01-19	2013-04-19
B32537B1335J000		2012-10-19	2013-01-19	2013-04-19
B32537B1334K000		2012-10-19	2013-01-19	2013-04-19
B32537B1334J000		2012-10-19	2013-01-19	2013-04-19
B32537B1226K000		2012-10-19	2013-01-19	2013-04-19
B32537B1226J000		2012-10-19	2013-01-19	2013-04-19
B32537B1225K000		2012-10-19	2013-01-19	2013-04-19
B32537B1225J000		2012-10-19	2013-01-19	2013-04-19
B32537B1224K000		2012-10-19	2013-01-19	2013-04-19
B32537B1224J000		2012-10-19	2013-01-19	2013-04-19



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32537B1155K000		2012-10-19	2013-01-19	2013-04-19
B32537B1155J000		2012-10-19	2013-01-19	2013-04-19
B32537B1154K000		2012-10-19	2013-01-19	2013-04-19
B32537B1154J000		2012-10-19	2013-01-19	2013-04-19
B32537B1107K000		2012-10-19	2013-01-19	2013-04-19
B32537B1107J000		2012-10-19	2013-01-19	2013-04-19
B32537B1106K000		2012-10-19	2013-01-19	2013-04-19
B32537B1106J000		2012-10-19	2013-01-19	2013-04-19
B32537B1105K000		2012-10-19	2013-01-19	2013-04-19
B32537B1105J000		2012-10-19	2013-01-19	2013-04-19
B32537B1104K000		2012-10-19	2013-01-19	2013-04-19
B32537B1104J000		2012-10-19	2013-01-19	2013-04-19
B32537B8473K000		2012-10-19	2013-01-19	2013-04-19
B32537B8473J000		2012-10-19	2013-01-19	2013-04-19
B32537B8335K000		2012-10-19	2013-01-19	2013-04-19

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

High reliability (wound)
Typical applications

- Measurement equipment
- Rough environments
- High-rel circuits in industrial electronics

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1): 55/100/56

Features

- Optimum self-healing capability
- Excellent short circuit protection
- Very high reliability

Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Construction with structured metallization
- Tubular winding
- Encapsulated in metal tube
- Insulating sleeve
- Face ends sealed with epoxy resin

Terminals

- Central axial leads, lead-free tinned

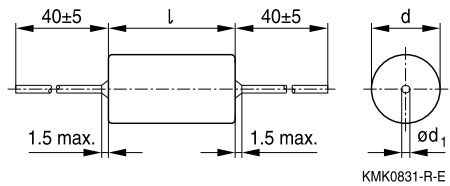
Marking

Manufacturer's logo, style (MKT-S),
 rated capacitance (coded)
 capacitance tolerance (code letter)
 rated voltage, date of manufacture (coded)

Delivery mode

Bulk (untaped)

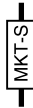
For notes on taping, refer to chapter "Taping and packing".

Dimensional drawing


Dimensions in mm

Diameter d	<8.5	8.5 ... 16	>16
Lead diameter d ₁	0.6	0.8	1.0

When bending leads take care to leave a clearance of 1 mm to the capacitor body.


Overview of types

Type	B32537				
V_R (V DC)	50	100	160	250	630
V_{RMS} (V AC)	20	35	60	90	200
C_R (μ F)					
0.033					
0.047					
0.068					
0.10					
0.15					
0.22					
0.33					
0.47					
0.68					
1.0					
1.5					
2.2					
3.3					
4.7					
6.8					
10					
22					
47					
100					


B32537
High reliability (wound)
Ordering codes and packing units

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $d \times l$	Ordering code (composition see below)	Untaped pcs./MOQ
V DC	V AC	μF	mm		
50	20	0.47	7.4×18.5	B32537B5474+000	200
		0.68	7.4×18.5	B32537B5684+000	200
		1.0	7.4×18.5	B32537B5105+000	200
		1.5	7.4×18.5	B32537B5155+000	200
		2.2	8.4×21.0	B32537B5225+000	200
		3.3	9.4×21.0	B32537B5335+000	80
		4.7	10.7×21.0	B32537B5475+000	80
		6.8	11.7×21.0	B32537B5685+000	80
		10	12.7×21.0	B32537B5106+000	80
100	35	0.10	7.4×18.5	B32537B1104+000	200
		0.15	7.4×18.5	B32537B1154+000	200
		0.22	7.4×18.5	B32537B1224+000	200
		0.33	7.4×18.5	B32537B1334+000	200
		0.47	7.4×18.5	B32537B1474+000	200
		0.68	7.4×18.5	B32537B1684+000	200
		1.0	8.4×21.0	B32537B1105+000	200
		1.5	8.4×21.0	B32537B1155+000	200
		2.2	9.4×21.0	B32537B1225+000	80
		3.3	9.4×21.0	B32537B1335+000	80
		4.7	11.7×21.0	B32537B1475+000	80
		6.8	10.7×34.0	B32537B1685+000	80
		10	10.7×34.0	B32537B1106+000	80
		22	15.7×34.0	B32537B1226+000	80
		47	20.7×34.0	B32537B1476+000	80
		100	29.7×34.0	B32537B1107+000	80

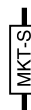
MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$


Ordering codes and packing units

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $d \times l$ mm	Ordering code (composition see below)	Untaped pcs./MOQ
V DC	V AC	μF			
160	60	0.10	7.4 × 18.5	B32537B2104+000	200
		0.15	7.4 × 18.5	B32537B2154+000	200
		0.22	7.4 × 18.5	B32537B2224+000	200
		0.33	7.4 × 18.5	B32537B2334+000	200
		0.47	8.4 × 21.0	B32537B2474+000	200
		0.68	8.4 × 21.0	B32537B2684+000	200
		1.0	9.4 × 21.0	B32537B2105+000	80
		1.5	10.7 × 21.0	B32537B2155+000	80
		2.2	11.7 × 21.0	B32537B2225+000	80
		3.3	10.7 × 34.0	B32537B2335+000	80
		4.7	12.7 × 34.0	B32537B2475+000	80
		6.8	12.7 × 34.0	B32537B2685+000	80
		10	15.7 × 34.0	B32537B2106+000	80
250	90	0.10	7.4 × 18.5	B32537B3104+000	200
		0.15	7.4 × 18.5	B32537B3154+000	200
		0.22	7.4 × 18.5	B32537B3224+000	200
		0.33	8.4 × 21.0	B32537B3334+000	200
		0.47	9.4 × 21.0	B32537B3474+000	80
		0.68	9.4 × 21.0	B32537B3684+000	80
		1.0	11.7 × 21.0	B32537B3105+000	80
		1.5	12.7 × 21.0	B32537B3155+000	80
		2.2	13.7 × 21.0	B32537B3225+000	80
		3.3	12.7 × 34.0	B32537B3335+000	80
		4.7	15.7 × 34.0	B32537B3475+000	80
		6.8	17.7 × 34.0	B32537B3685+000	80
		10	20.7 × 34.0	B32537B3106+000	80

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%


B32537
High reliability (wound)
Ordering codes and packing units

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $d \times l$ mm	Ordering code (composition see below)	Untaped pcs./MOQ
V DC	V AC	μF			
630	200	0.033	7.4 × 18.5	B32537B8333+000	200
		0.047	7.4 × 18.5	B32537B8473+000	200
		0.068	8.4 × 21.0	B32537B8683+000	200
		0.10	9.4 × 21.0	B32537B8104+000	80
		0.15	9.4 × 21.0	B32537B8154+000	80
		0.22	11.7 × 21.0	B32537B8224+000	80
		0.33	12.7 × 21.0	B32537B8334+000	80
		0.47	13.7 × 21.0	B32537B8474+000	80
		0.68	12.7 × 34.0	B32537B8684+000	80
		1.0	15.7 × 34.0	B32537B8105+000	80
		1.5	17.7 × 34.0	B32537B8155+000	80
		2.2	20.7 × 34.0	B32537B8225+000	80
		3.3	25.7 × 34.0	B32537B8335+000	80
4.7	29.7 × 34.0	B32537B8475+000	80		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$

Technical data

Operating temperature range	Max. operating temperature $T_{op,max}$ +125 °C				
	Upper category temperature T_{max} +100 °C				
	Lower category temperature T_{min} -55 °C				
	Rated temperature T_R +85 °C				
Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values)	C_R (μF)	≤ 0.47	$0.47 < C_R \leq 4.7$	$4.7 < C_R \leq 10.0$	> 10.0
	at 1 kHz	7	8	8	10
	at 10 kHz	15	22	25	—
Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values)	C_R				
	$\leq 0.33 \mu F$	$> 15000 M\Omega$			
	$> 0.33 \mu F$	$> 5000 s$			
DC test voltage	$1.4 \cdot V_R, 2 s$				
Category voltage V_C (continuous operation with V_{DC} or V_{AC} at $f \leq 60 Hz$)	T_A (°C)	DC voltage derating	AC voltage derating		
	$T_A \leq 85$	$V_C = V_R$	$V_{C,RMS} = V_{RMS}$		
	$85 < T_A \leq 100$	$V_C = V_R \cdot (165 - T_A)/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$		
Operating voltage V_{op} for short operating periods (V_{DC} or V_{AC} at $f \leq 60 Hz$)	T_A (°C)	DC voltage (max. hours)	AC voltage (max. hours)		
	$T_A \leq 100$	$V_{op} = 1.25 \cdot V_C$ (2000 h)	$V_{op} = 1.0 \cdot V_{C,RMS}$ (2000 h)		
	$100 < T_A \leq 125$	$V_{op} = 0.5 \cdot V_R$ (1000 h)	$V_{op} = 0.5 \cdot V_{RMS}$ (1000 h)		
Damp heat test	56 days/40 °C/93% relative humidity				
Limit values after damp heat test	Capacitance change $ \Delta C/C $	$\leq 5\%$			
	Dissipation factor change $\Delta \tan \delta$	$\leq 5 \cdot 10^{-3}$ (at 1 kHz)			
	Insulation resistance R_{ins}	$\geq 50\%$ of minimum as-delivered values			
Reliability:					
Failure rate λ	1 fit ($\leq 1 \cdot 10^{-9}/h$) at $0.5 \cdot V_R, 40$ °C				
Service life t_{SL}	200 000 h at $1.0 \cdot V_R, 85$ °C				
	For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".				
Failure criteria:					
Total failure	Short circuit or open circuit				
Failure due to variation of parameters	Capacitance change $ \Delta C/C $	$> 10\%$			
	Dissipation factor $\tan \delta$	$> 1.5 \cdot$ upper limit value			
	Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$	$< 150 M\Omega$ ($C_R \leq 0.33 \mu F$) $< 50 s$ ($C_R > 0.33 \mu F$)			



B32537

High reliability (wound)

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/μs.

Note:

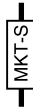
The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Length of capacitor		18.5 mm	21 mm	34 mm
V _R V DC	V _{RMS} V AC	dV/dt in V/μs		
50	20	2.5	1.5	–
100	35	13	9	6
160	60	20	12	8
250	90	23	16	10
630	200	40	26	18

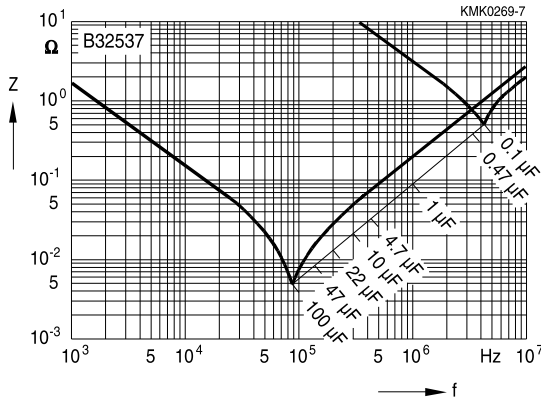
k₀ values

Length of capacitor		18.5 mm	21 mm	34 mm
V _R V DC	V _{RMS} V AC	k ₀ in V ² /μs		
50	20	250	150	–
100	35	2 600	1 800	1 200
160	60	6 400	3 840	2 560
250	90	11 500	8 000	5 000
630	200	50 400	32 800	22 700



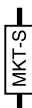
Impedance Z versus frequency f

(typical values)



Permissible AC voltage V_{RMS} versus frequency f

Values can be obtained on request. In specific cases please provide a scaled voltage/ time graph and state operating conditions.



B32537

High reliability (wound)

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

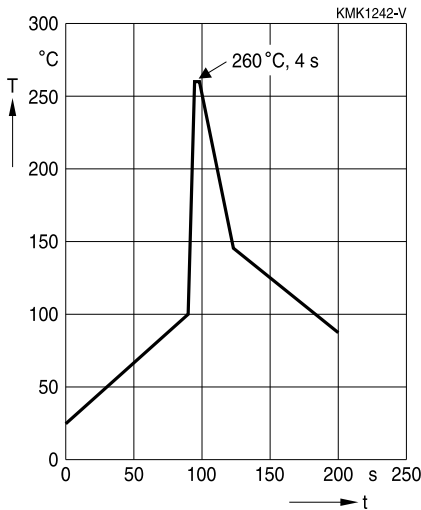
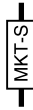
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria: Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm) MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



B32537

High reliability (wound)

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Type	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro-ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



B32537

High reliability (wound)

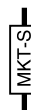
3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

Caution:

Consult us first if you wish to embed uncoated types!

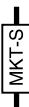


Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



B32537

High reliability (wound)

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Symbols and terms

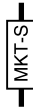
Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



B32537

High reliability (wound)

Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impuls Kennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Ambient temperature	Umgebungstemperatur
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature	Betriebstemperatur
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer
V_{AC}	AC voltage	Wechselspannung



Symbol	English	German
V_C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebssspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
\hat{V}_R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

Important notes



The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.







We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.
7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard**. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

-  [View B32537B2224K on WIN SOURCE](#)
-  [EPCOS \(TDK\) Information](#)

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management